

International  
**IR** Rectifier

## ST303S SERIES

**INVERTER GRADE THYRISTORS**

**Stud Version**

### Features

- Center amplifying gate
- High surge current capability
- Low thermal impedance
- High speed performance

300A

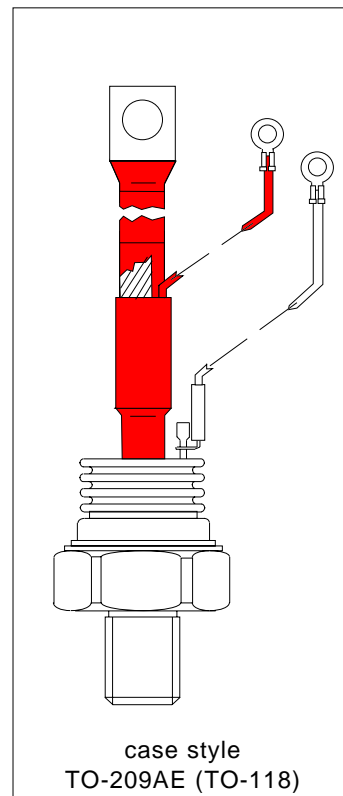
### Typical Applications

- Inverters
- Choppers
- Induction heating
- All types of force-commutated converters

DataSheet4U.com

### Major Ratings and Characteristics

Parameters	ST303S	Units
$I_{T(AV)}$	300	A
@ $T_C$	65	°C
$I_{T(RMS)}$	471	A
$I_{TSM}$ @ 50Hz	7950	A
@ 60Hz	8320	A
$I^2t$ @ 50Hz	316	KA <sup>2</sup> s
@ 60Hz	288	KA <sup>2</sup> s
$V_{DRM}/V_{RRM}$	400 to 1200	V
$t_q$	10 - 20	μs
$T_J$	- 40 to 125	°C



**ST303S Series**

Bulletin I25173 rev. C 03/03

International  
**IR** Rectifier**ELECTRICAL SPECIFICATIONS**

## Voltage Ratings

Type number	Voltage Code	$V_{DRM}/V_{RRM}$ , maximum repetitive peak voltage V	$V_{RSM}$ , maximum non-repetitive peak voltage V	$I_{DRM}/I_{RRM}$ max. @ $T_J = T_J$ max. mA
ST303S	04	400	500	50
	08	800	900	
	12	1200	1300	

## Current Carrying Capability

Frequency							Units
	$I_{TM}$	$V_{DRM}$	$I_{TM}$	$V_{DRM}$	$I_{TM}$	$V_{DRM}$	
50Hz	670	470	1050	940	5240	4300	A
400Hz	480	330	1021	710	1800	1270	
1000Hz	230	140	760	470	730	430	
2500Hz	35	-	150	-	90	-	
Recovery voltage Vr	50	50	50	50	50	50	V
Voltage before turn-on Vd	$V_{DRM}$		$V_{DRM}$		$V_{DRM}$		
Rise of on-state current di/dt	50	50	-	-	-	-	A/µs
Case temperature	40	65	40	65	40	65	°C
Equivalent values for RC circuit	10Ω / 0.47µF		10Ω / 0.47µF		10Ω / 0.47µF		

## On-state Conduction

Parameter	ST303S	Units	Conditions	
$I_{T(AV)}$ Max. average on-state current @ Case temperature	300	A	180° conduction, half sine wave	
	65	°C		
$I_{T(RMS)}$ Max. RMS on-state current	471	A	DC @ 45°C case temperature	
$I_{TSM}$ Max. peak, one half cycle, non-repetitive surge current	7950		t = 10ms	No voltage reappplied
	8320		t = 8.3ms	reappplied
	6690		t = 10ms	100% $V_{RRM}$
$I^2t$ Maximum $I^2t$ for fusing	7000	t = 8.3ms	reappplied	
	316	t = 10ms	No voltage reappplied	
		t = 8.3ms	reappplied	
		t = 10ms	100% $V_{RRM}$	
288	t = 8.3ms	reappplied		
224	t = 10ms	100% $V_{RRM}$		
204	t = 8.3ms	reappplied		
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	3160	KA <sup>2</sup> /s	t = 0.1 to 10ms, no voltage reappplied	

## On-state Conduction

Parameter	ST303S	Units	Conditions
$V_{TM}$ Max. peak on-state voltage	2.16	V	$I_{TM} = 1255A, T_J = T_J \text{ max}, t_p = 10\text{ms sine wave pulse}$
$V_{T(TO)1}$ Low level value of threshold voltage	1.44		$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
$V_{T(TO)2}$ High level value of threshold voltage	1.46		$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
$r_{t1}$ Low level value of forward slope resistance	0.57	m $\Omega$	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
$r_{t2}$ High level value of forward slope resistance	0.56		$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
$I_H$ Maximum holding current	600	mA	$T_J = 25^\circ\text{C}, I_T > 30A$
$I_L$ Typical latching current	1000		$T_J = 25^\circ\text{C}, V_A = 12V, R_a = 6\Omega, I_G = 1A$

## Switching

Parameter	ST303S	Units	Conditions
di/dt Max. non-repetitive rate of rise of turned-on current	1000	A/ $\mu\text{s}$	$T_J = T_J \text{ max}, V_{DRM} = \text{rated } V_{DRM}$ $I_{TM} = 2 \times \text{di/dt}$
$t_d$ Typical delay time	0.80	$\mu\text{s}$	$T_J = 25^\circ\text{C}, V_{DM} = \text{rated } V_{DRM}, I_{TM} = 50A \text{ DC}, t_p = 1\mu\text{s}$ Resistive load, Gate pulse: 10V, 5 $\Omega$ source
$t_q$ Max. turn-off time	10 - 20		$T_J = T_J \text{ max}, I_{TM} = 550A, \text{commutating di/dt} = 40A/\mu\text{s}$ $V_R = 50V, t_p = 500\mu\text{s}, dv/dt = 200V/\mu\text{s}$

## Blocking

Parameter	ST303S	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	500	V/ $\mu\text{s}$	$T_J = T_J \text{ max}, \text{linear to } 80\% V_{DRM}, \text{higher value available on request}$
$I_{RRM} / I_{DRM}$ Max. peak reverse and off-state leakage current	50	mA	$T_J = T_J \text{ max}, \text{rated } V_{DRM} / V_{RRM} \text{ applied}$

## Triggering

Parameter	ST303S	Units	Conditions
$P_{GM}$ Maximum peak gate power	60	W	$T_J = T_J \text{ max}, f = 50\text{Hz}, d\% = 50$
$P_{G(AV)}$ Maximum average gate power	10		
$I_{GM}$ Max. peak positive gate current	10	A	$T_J = T_J \text{ max}, t_p \leq 5\text{ms}$
$+V_{GM}$ Maximum peak positive gate voltage	20	V	$T_J = T_J \text{ max}, t_p \leq 5\text{ms}$
$-V_{GM}$ Maximum peak negative gate voltage	5		
$I_{GT}$ Max. DC gate current required to trigger	200	mA	$T_J = 25^\circ\text{C}, V_A = 12V, R_a = 6\Omega$
$V_{GT}$ Max. DC gate voltage required to trigger	3		
$I_{GD}$ Max. DC gate current not to trigger	20	mA	$T_J = T_J \text{ max}, \text{rated } V_{DRM} \text{ applied}$
$V_{GD}$ Max. DC gate voltage not to trigger	0.25		

**ST303S Series**

Bulletin I25173 rev. C 03/03

International  
**IR** Rectifier**Thermal and Mechanical Specifications**

Parameter	ST303S	Units	Conditions
$T_J$ Max. junction operating temperature range	-40 to 125	°C	
$T_{stg}$ Max. storage temperature range	-40 to 150		
$R_{thJC}$ Max. thermal resistance, junction to case	0.10	K/W	DC operation
$R_{thCS}$ Max. thermal resistance, case to heatsink	0.03		Mounting surface, smooth, flat and greased
T Mounting torque, $\pm 10\%$	48.5 (425)	Nm (lbf-in)	Non lubricated threads
wt Approximate weight	535	g	
Case style	TO-209AE (TO-118)		See Outline Table

 **$\Delta R_{thJC}$  Conduction**(The following table shows the increment of thermal resistance  $R_{thJC}$  when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.011	0.008	K/W	$T_J = T_{J \text{ max.}}$
120°	0.013	0.014		
90°	0.017	0.018		
60°	0.025	0.026		
30°	0.041	0.042		

**Ordering Information Table**

Device Code								
1	2	3	4	5	6	7	8	9
ST	30	3	S	12	P	F	K	0
<b>1</b>	- Thyristor							
<b>2</b>	- Essential part number							
<b>3</b>	- 3 = Fast turn off							
<b>4</b>	- S = Compression bonding Stud							
<b>5</b>	- Voltage code: Code x 100 = $V_{RRM}$ (See Voltage Ratings table)							
<b>6</b>	- P = Stud base 3/4" 16UNF-2A							
<b>7</b>	- Reapplied dv/dt code (for $t_q$ test condition)							
<b>8</b>	- $t_q$ code							
<b>9</b>	- 0 = Eyelet terminals (Gate and Aux. Cathode Leads) 1 = Fast-on terminals (Gate and Aux. Cathode Leads)							
<b>dv/dt - <math>t_q</math> combinations available</b>								
		<b>dv/dt (V/<math>\mu</math>s)</b>		<b>200</b>				
<b><math>t_q</math> (<math>\mu</math>s)</b> up to 800V	10	FN						
	20	FK						
<b><math>t_q</math> (<math>\mu</math>s)</b> only for 1000/1200V	20	FK						

Outline Table

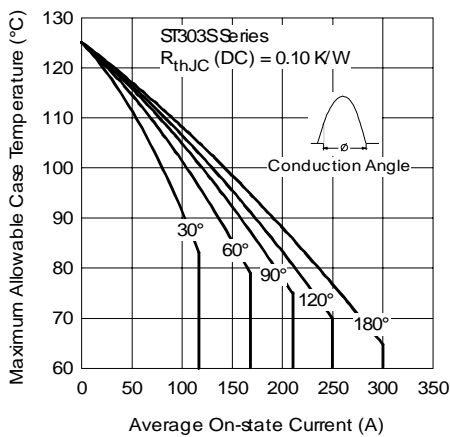
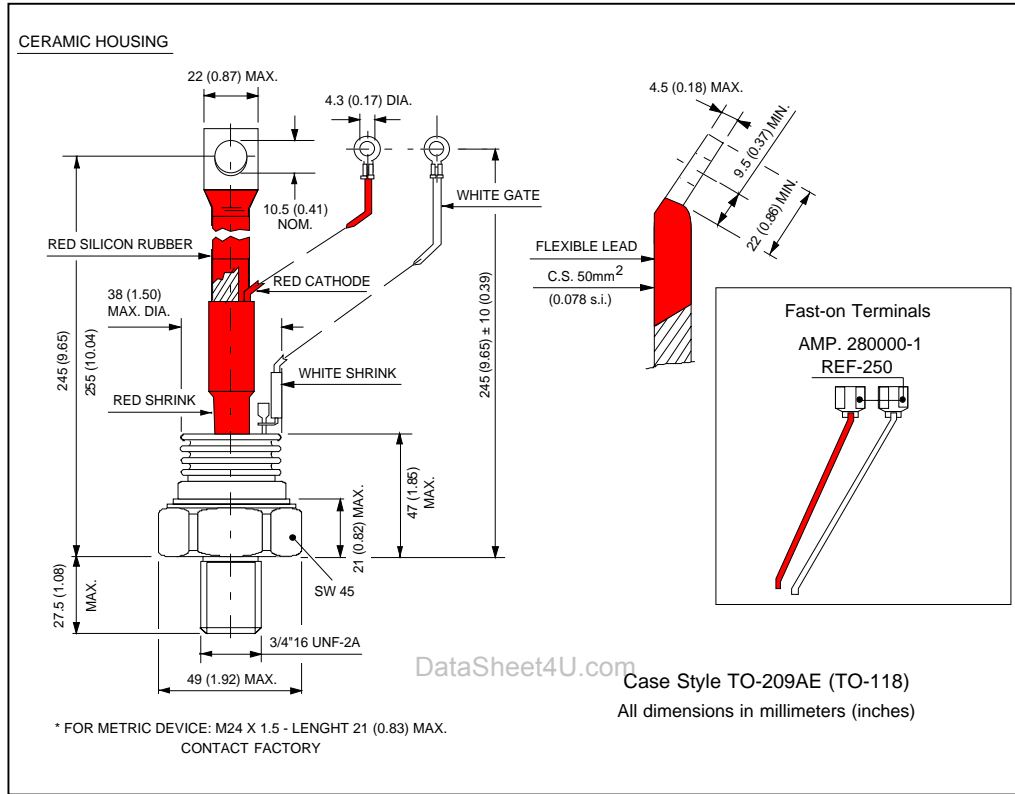


Fig. 1 - Current Ratings Characteristics

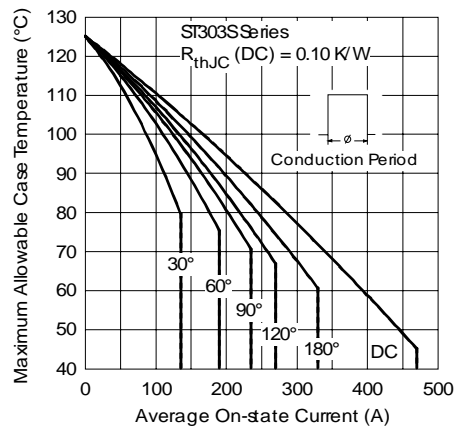


Fig. 2 - Current Ratings Characteristics

**ST303S Series**

Bulletin 125173 rev. C 03/03

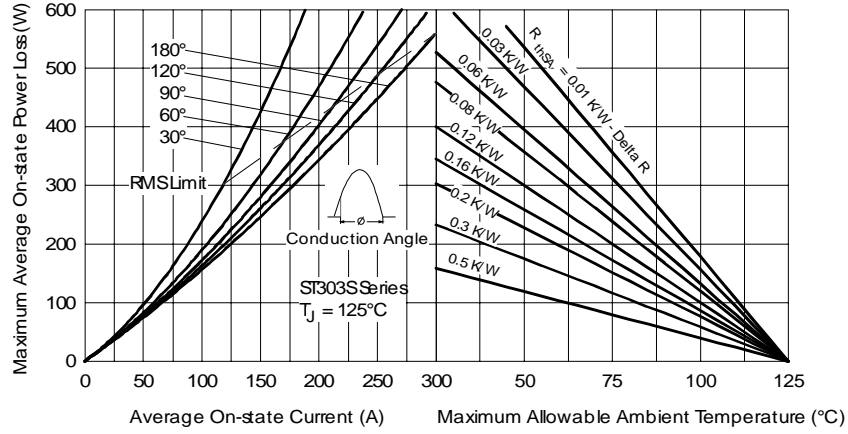


Fig. 3 - On-state Power Loss Characteristics

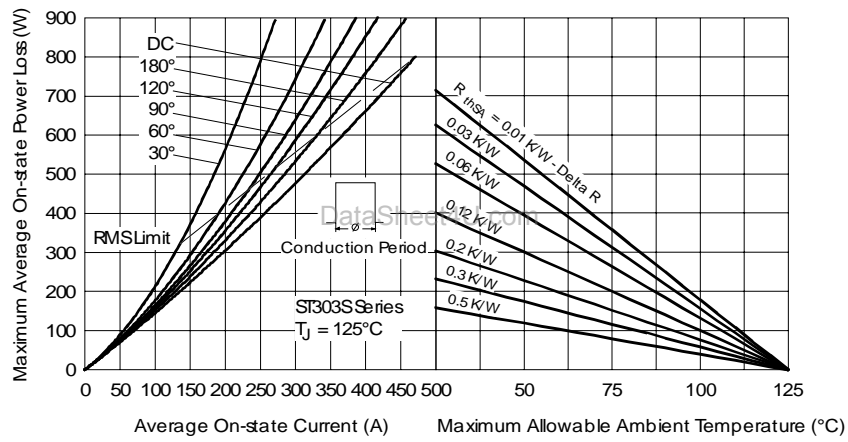


Fig. 4 - On-state Power Loss Characteristics

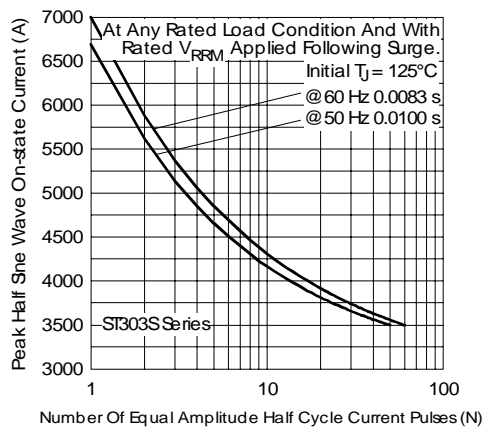


Fig. 5 - Maximum Non-repetitive Surge Current

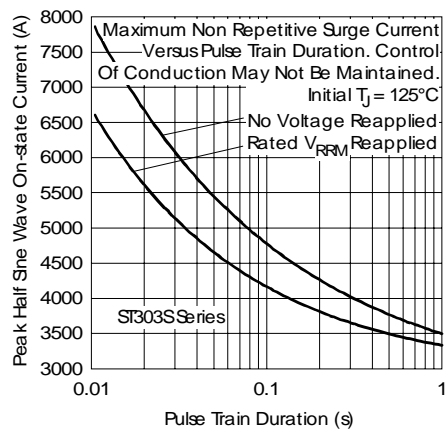


Fig. 6 - Maximum Non-repetitive Surge Current

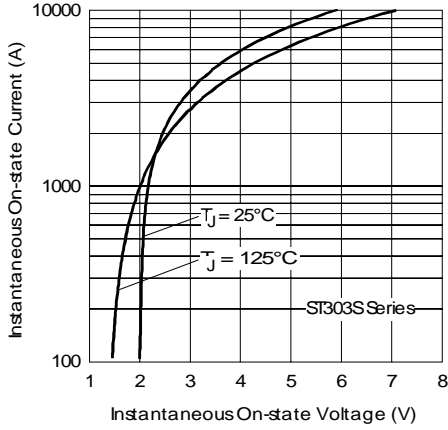


Fig. 7 - On-state Voltage Drop Characteristics

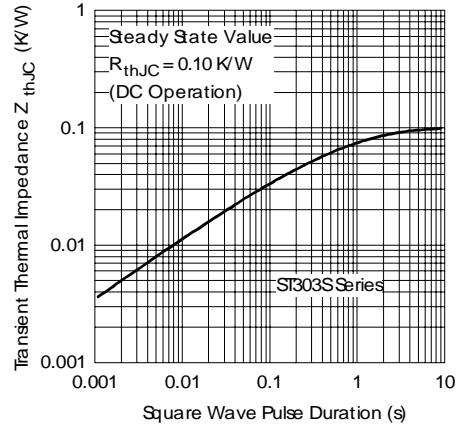


Fig. 8 - Thermal Impedance  $Z_{thJC}$  Characteristic

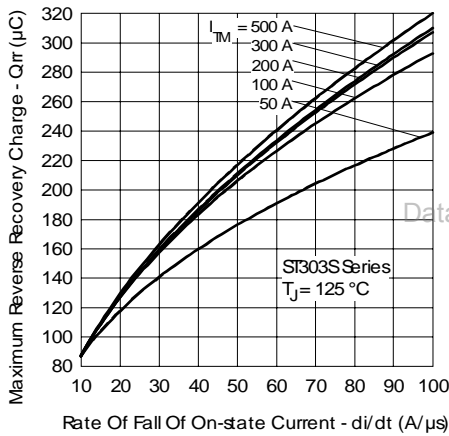


Fig. 9 - Reverse Recovered Charge Characteristics

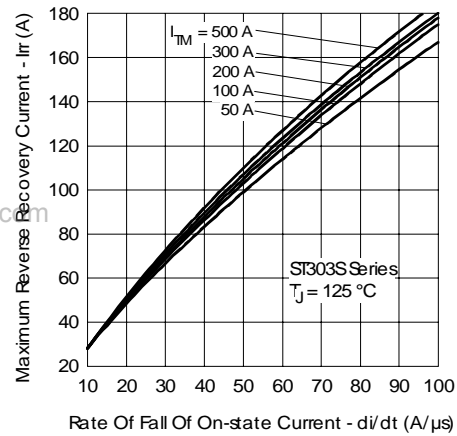


Fig. 10 - Reverse Recovery Current Characteristics

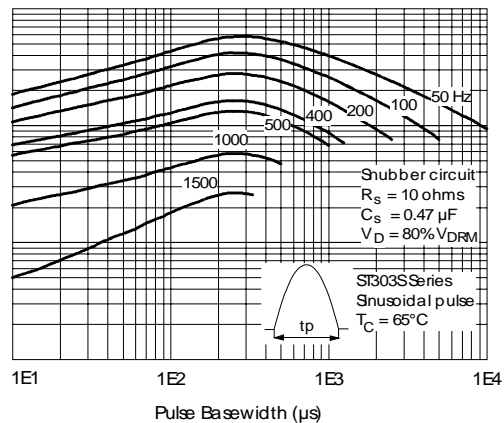
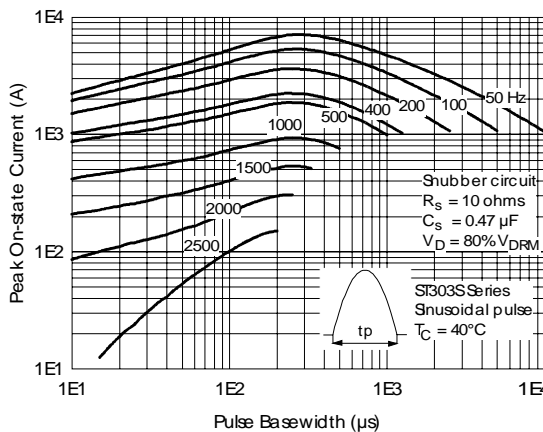


Fig. 11 - Frequency Characteristics

**ST303S Series**

Bulletin I25173 rev. C 03/03

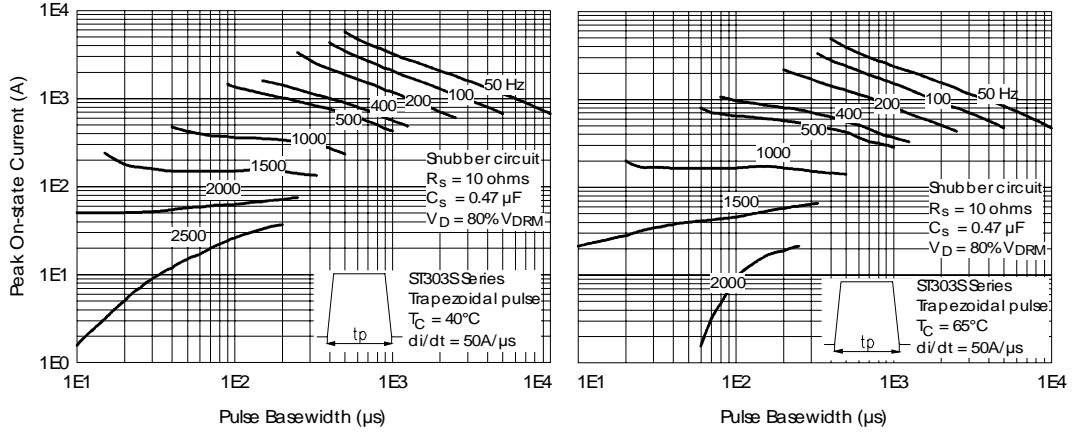


Fig. 12 - Frequency Characteristics

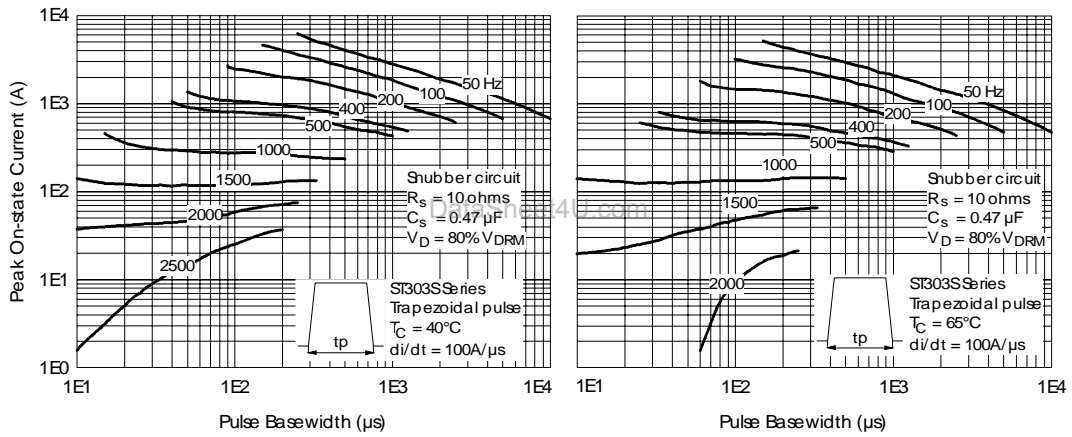


Fig. 13 - Frequency Characteristics

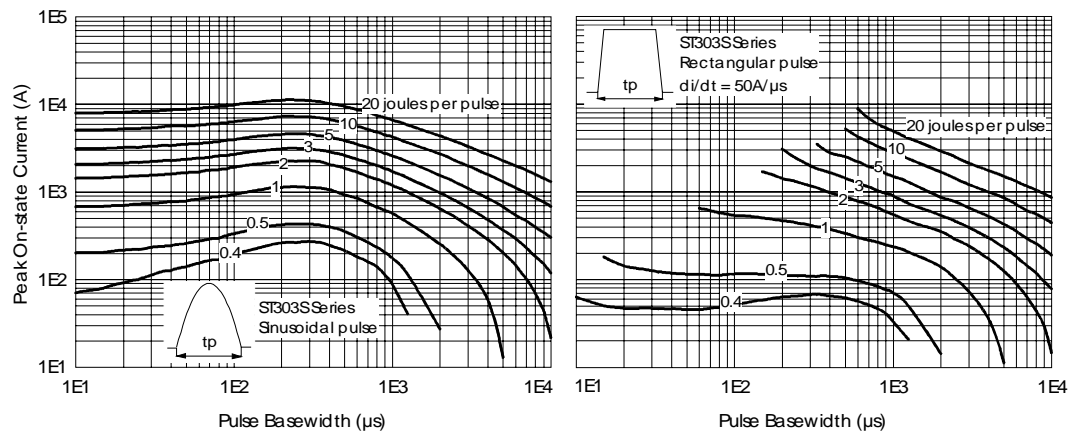


Fig. 14 - Maximum On-state Energy Power Loss Characteristics



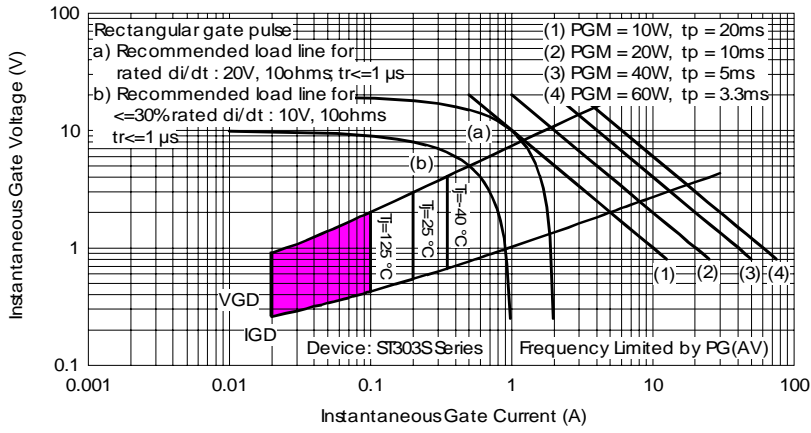


Fig. 15 - Gate Characteristics

et4U.com

DataSheet4U.com

Data and specifications subject to change without notice.  
 This product has been designed and qualified for Industrial Level.  
 Qualification Standards can be found on IR's Web site.